

2SJ550(L), 2SJ550(S)

Silicon P Channel MOS FET

REJ03G0897-0300 (Previous: ADE-208-633A) Rev.3.00 Sep 07, 2005

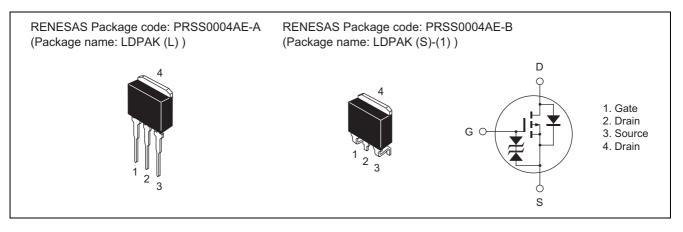
Description

High speed power switching

Features

- Low on-resistance $R_{DS (on)} = 0.075 \Omega$ typ.
- Low drive current.
- 4 V gate drive devices.
- High speed switching.

Outline





Absolute Maximum Ratings

			(Ta = 25°C)
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	-60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	-15	А
Drain peak current	I _{D (pulse)} Note 1	-60	А
Body to drain diode reverse drain current	I _{DR}	-15	А
Avalanche current	I _{AP} Note 3	-15	А
Avalanche energy	E _{AR} Note 3	19	mJ
Channel dissipation	Pch Note 2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 µs, duty cycle \leq 1%

2. Value at Tc = 25°C

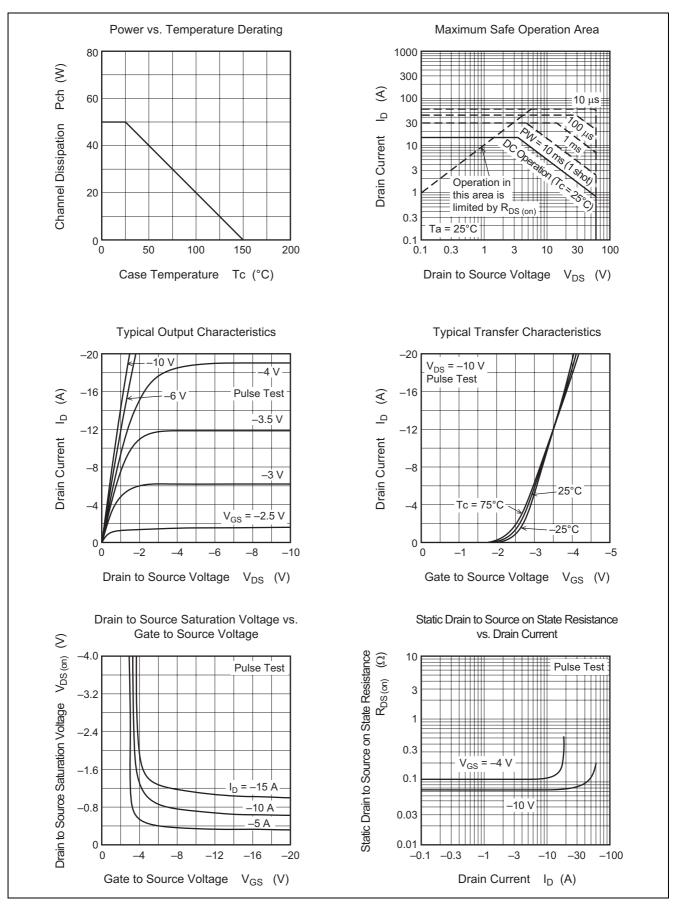
3. Value at Tch = 25° C, Rg $\geq 50 \Omega$

Electrical Characteristics

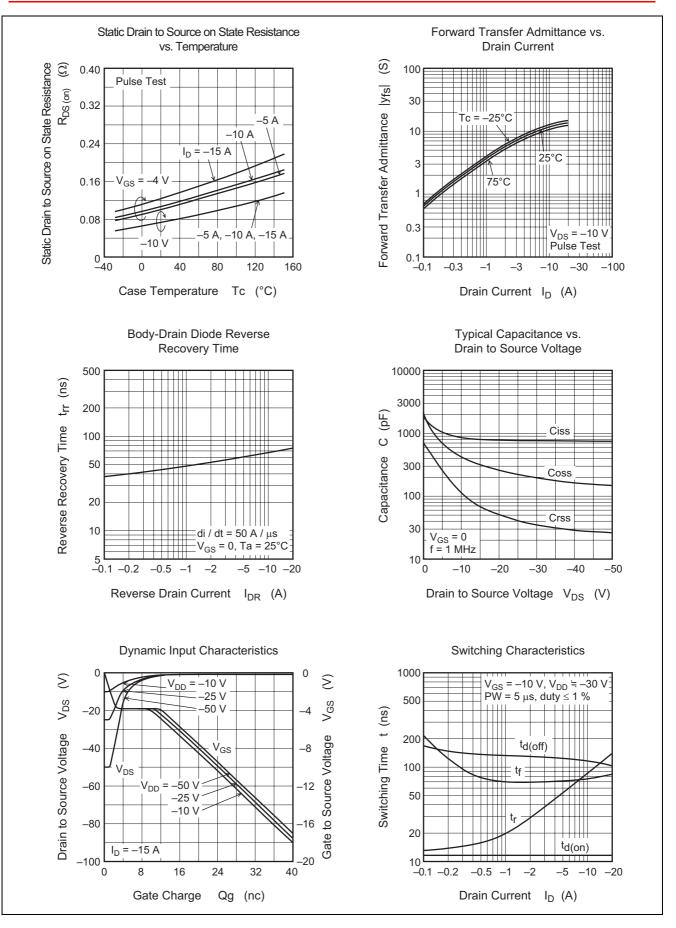
						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-60	—		V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	-10	μA	$V_{DS} = -60 V, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	-1.0	—	-2.0	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	R _{DS (on)}	_	0.075	0.095	Ω	$I_D = -8 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note 4}}$
	R _{DS (on)}	—	0.105	0.155	Ω	$I_D = -8 \text{ A}, V_{GS} = -4 \text{ V}^{Note 4}$
Forward transfer admittance	y _{fs}	6.5	11		S	$I_D = -8 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss		850		pF	$V_{DS} = -10 \text{ V}$
Output capacitance	Coss		420		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		110		pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	12	_	ns	$V_{GS} = -10 V$
Rise time	tr	—	75	_	ns	$I_D = -8 A$
Turn-off delay time	t _{d (off)}	_	125	—	ns	$R_L = 3.75 \ \Omega$
Fall time	t _f		75	—	ns	
Body to drain diode forward voltage	V _{DF}		-1.1	_	V	$I_F = -15 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		70		ns	$I_F = -15 \text{ A}, V_{GS} = 0$
						di _F /dt = 50 A/µs

Note: 4. Pulse test

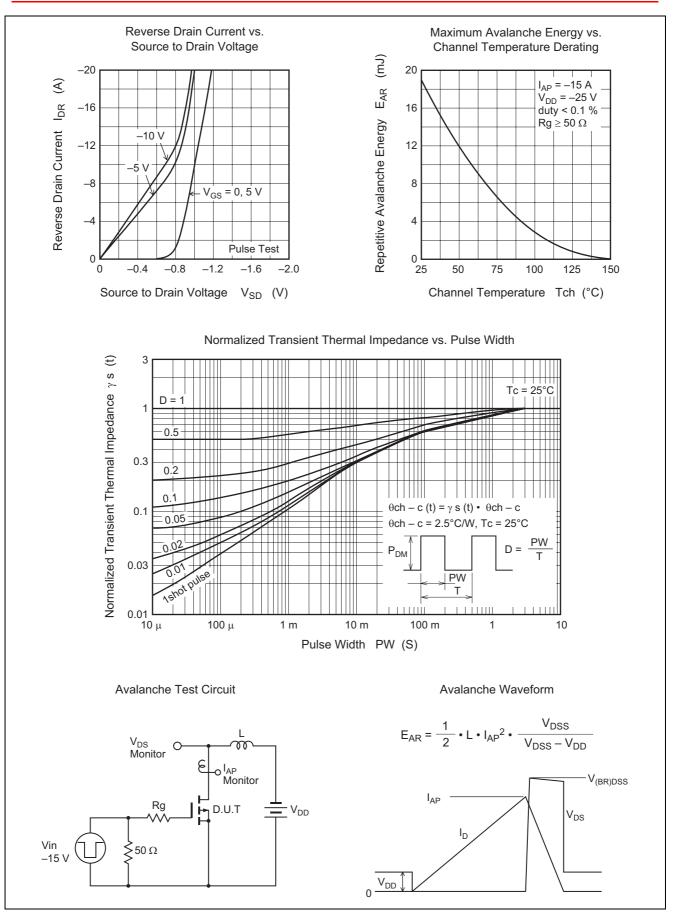
Main Characteristics



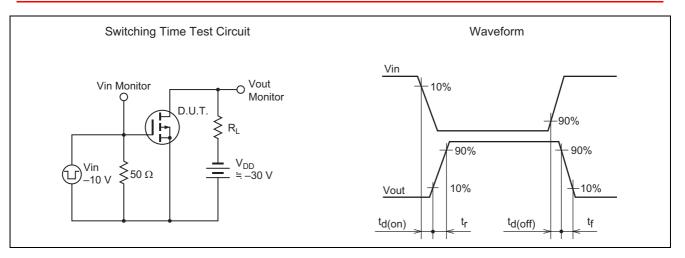






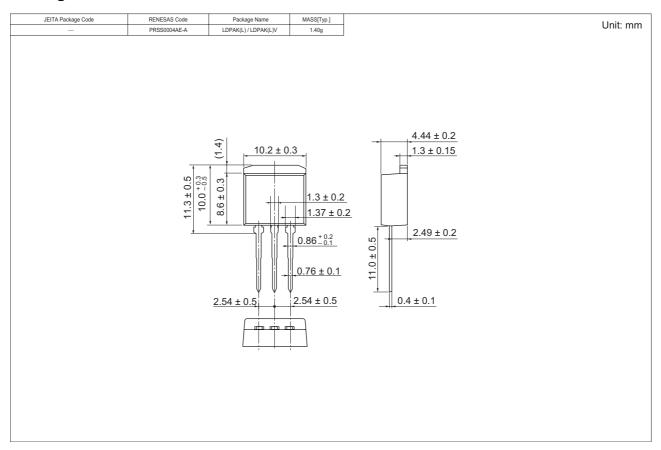


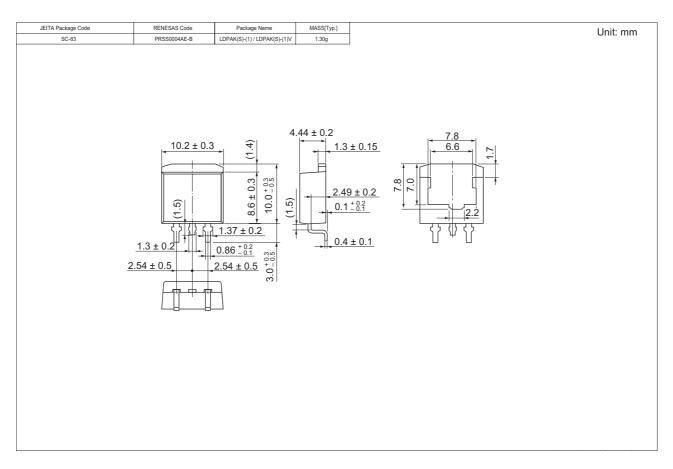






Package Dimensions







Ordering Information

Part Name	Quantity	Shipping Container
2SJ550L-E	500 pcs	Box (Sack)
2SJ550STL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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